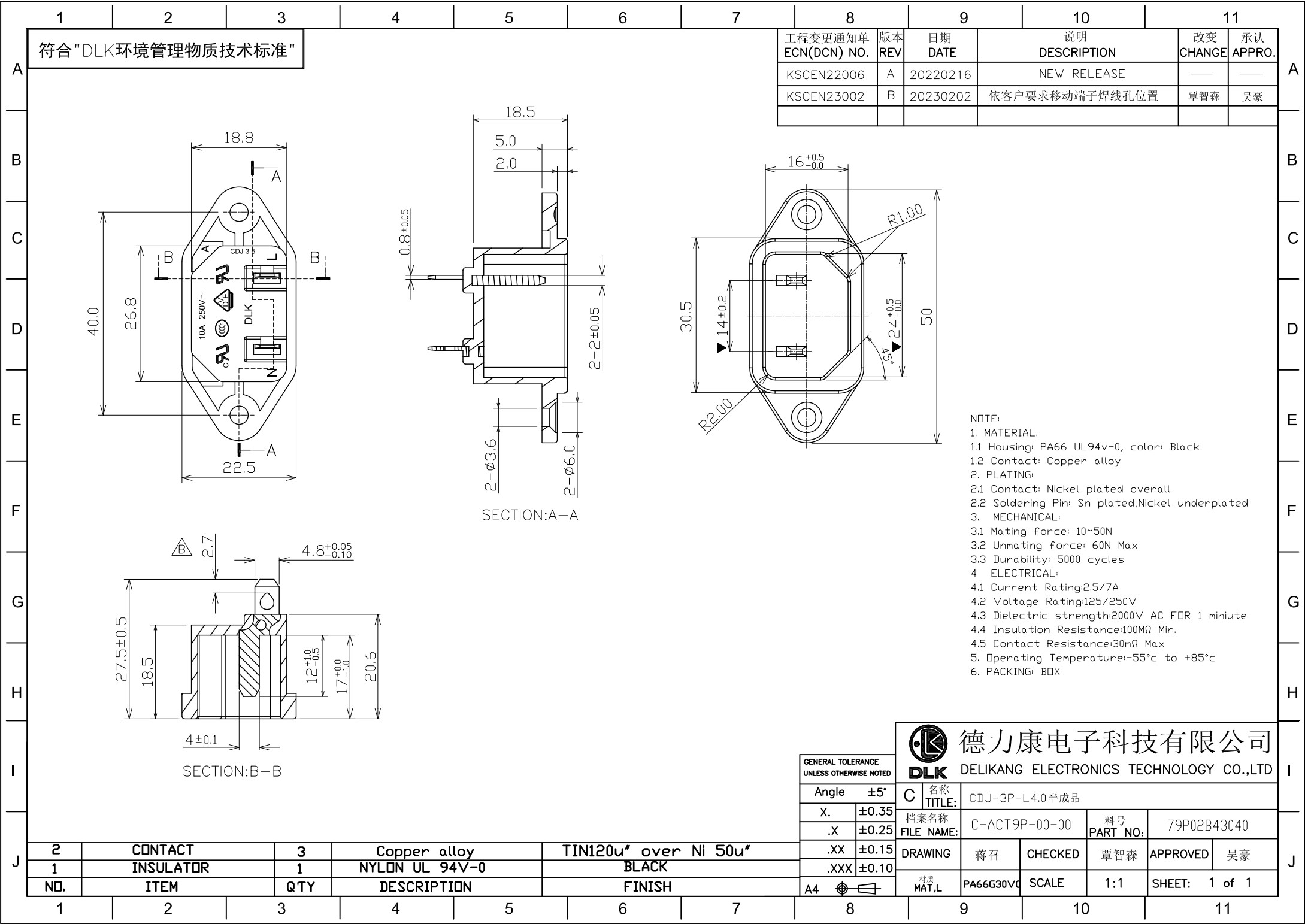




工程变更通知单 ECN(DCN) NO.	版本 REV	日期 DATE	说明 DESCRIPTION	改变 CHANGE	承认 APPRO.
KSCEN22006	A	20220216	NEW RELEASE	—	—
KSCEN23002	B	20230202	依客户要求移动端子焊线孔位置	覃智森	吴豪

NOTE:
1. MATERIAL:
1.1 Housing: PA66 UL94v-0, color: Black
1.2 Contact: Copper alloy
2. PLATING:
2.1 Contact: Nickel plated overall
2.2 Soldering Pin: Sn plated,Nickel underplated
3. MECHANICAL:
3.1 Mating force: 10~50N
3.2 Unmating force: 60N Max
3.3 Durability: 5000 cycles
4. ELECTRICAL:
4.1 Current Rating:2.5/7A
4.2 Voltage Rating:125/250V
4.3 Dielectric strength:2000V AC FOR 1 minute
4.4 Insulation Resistance:100MΩ Min.
4.5 Contact Resistance:30mΩ Max
5. Operating Temperature:-55℃ to +85℃
6. PACKING: BOX



德力康电子科技有限公司



DELIKANG ELECTRONICS TECHNOLOGY CO.,LTD

GENERAL TOLERANCE
UNLESS OTHERWISE NOTED

Angle	±5°
X.	±0.35
.X	±0.25
.XX	±0.15
.XXX	±0.10
A4	

C 名称 TITLE:	CDJ-3P-L 4.0 半成品			
档案名称 FILE NAME:	C-ACT9P-00-00	料号 PART NO:	79P02B43040	
DRAWING	蒋召	CHECKED	覃智森	APPROVED 吴豪
材质 MAT.L	PA66G30V0	SCALE	1:1	SHEET: 1 of 1

符合“DLK环境管理物质技术标准”

2	CONTACT	3	Copper alloy	TIN120u" over Ni 50u"
1	INSULATOR	1	NYLON UL 94V-0	BLACK
NO.	ITEM	QTY	DESCRIPTION	FINISH

1	2	3	4	5	6	7	8	9	10	11
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